

ROHS COMPLIANT

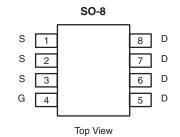
HALOGEN

FREE Available

**Vishay Siliconix** 

# N-Channel 30-V (D-S) MOSFET with Schottky Diode

| PRODUCT SUMMARY     |                                  |                                 |                       |  |  |  |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | <b>R<sub>DS(on)</sub> (</b> Ω)   | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
| 30                  | 0.0115 at V <sub>GS</sub> = 10 V | 12 <sup>e</sup>                 | 13.7 nC               |  |  |  |
| 50                  | 0.0145 at $V_{GS}$ = 4.5 V       | V 12 <sup>e</sup>               | 13.7 110              |  |  |  |

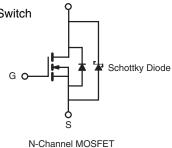


#### FEATURES

- Halogen-free According to IEC 61249-2-21
   Definition
- SkyFET<sup>®</sup> Monolithic TrenchFET<sup>®</sup> Power MOSFET and Schottky Diode
- 100 % R<sub>a</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Notebook PC
- System Power
- Buck Converter
- Synchronous Rectifier Switch



D

Ordering Information: Si4646DY-T1-E3 (Lead (Pb)-free) Si4646DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

| Parameter  | Symbol  | Limit           | Unit  |    |  |
|--|---|-----------------|---|----|--|
| Drain-Source Voltage                               |   | V <sub>DS</sub> | 30  | v  |  |
| Gate-Source Voltage                                |   | V <sub>GS</sub> | ± 20  | v  |  |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | $T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$ | Ι <sub>D</sub>  | 12 <sup>e</sup><br>12 <sup>e</sup><br>12 <sup>b, c</sup><br>9.5 <sup>b, c</sup> |    |  |
| Pulsed Drain Current                               |   | I <sub>DM</sub> | 50  | A  |  |
| Continuous Source-Drain Diode Current              | $T_{C} = 25 \text{ °C}$ $T_{A} = 25 \text{ °C}$   | ١ <sub>S</sub>  | 5.6<br>2.7 <sup>b, c</sup>  |    |  |
| Single Pulse Avalanche Current                     | L = 0.1 mH  | I <sub>AS</sub> | 20  |    |  |
| Single Pulse Avalanche Energy                      | L = 0.1 mH  | E <sub>AS</sub> | 20  | mJ |  |
| Maximum Power Dissipation                          | $T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$   | P <sub>D</sub>  | 6.25<br>4.0   | w  |  |
|  | $T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$   | U               | 3.0 <sup>b, c</sup><br>1.9 <sup>b, c</sup>                                      |    |  |
| Operating Junction and Storage Temperature Range   | T <sub>J</sub> , T <sub>stq</sub>   | - 55 to 150     | °C  |    |  |

| THERMAL RESISTANCE RATINGS                  |              |                   |      |      |      |  |  |
|---|--------------|-------------------|------|------|------|--|--|
| Parameter                                   |              | Symbol            | Тур. | Max. | Unit |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 33   | 42   | °C/W |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 16   | 20   | 0/11 |  |  |

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 90 °C/W.

e. Package limited.

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| <b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted |                     |  |      |        |        |      |  |
|--|---------------------|--|------|--------|--------|------|--|
| Parameter  | Symbol              | Test Conditions  | Min. | Тур.   | Max.   | Unit |  |
| Static   |                     |  |      |        |        |      |  |
| Drain-Source Breakdown Voltage                                       | V <sub>DS</sub>     | $V_{GS} = 0 V, I_D = 1 mA$   | 30   |        |        | V    |  |
| Gate-Source Threshold Voltage  | V <sub>GS(th)</sub> | $V_{DS} = V_{GS}$ , $I_D = 1 \text{ mA}$   | 1.2  |        | 2.5    |      |  |
| Gate-Source Leakage  | I <sub>GSS</sub>    | $V_{DS} = 0 V, V_{GS} = \pm 20 V$  |      |        | ± 100  | nA   |  |
| Zero Gate Voltage Drain Current                                      | I <sub>DSS</sub>    | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$  |      | 0.035  | 0.2    | m^   |  |
| Zero Gale volage Drain Current                                       |                     | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 100 ^{\circ}\text{C}$          |      | 3.5    | 35     | - mA |  |
| On -State Drain Current <sup>a</sup>                                 | I <sub>D(on)</sub>  | $V_{DS} \ge 5$ V, $V_{GS}$ = 10 V  | 20   |        |        | А    |  |
|  | <b>D</b>            | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A  |      | 0.0092 | 0.0115 | Ω    |  |
| Drain-Source On-State Resistance <sup>a</sup>                        | R <sub>DS(on)</sub> | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7 A  |      | 0.0115 | 0.0145 |      |  |
| Forward Transconductance <sup>a</sup>                                | 9 <sub>fs</sub>     | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A  |      | 38     |        | S    |  |
| Dynamic <sup>b</sup>   |                     | · · · · ·  |      |        |        |      |  |
| Input Capacitance  | C <sub>iss</sub>    |  |      | 1790   |        | pF   |  |
| Output Capacitance   | C <sub>oss</sub>    | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                     |      | 310    |        |      |  |
| Reverse Transfer Capacitance   | C <sub>rss</sub>    |  |      | 130    |        |      |  |
| Total Gate Charge  | Qg                  | $V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$ |      | 30     | 45     | nC   |  |
|  |                     |  |      | 13.7   | 21     |      |  |
| Gate-Source Charge   | Q <sub>gs</sub>     | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$                  |      | 5      |        |      |  |
| Gate-Drain Charge  | Q <sub>gd</sub>     |  |      | 4      |        |      |  |
| Gate Resistance  | Rg                  | f = 1 MHz  | 0.3  | 1.2    | 2.4    | Ω    |  |
| Turn-On Delay Time   | t <sub>d(on)</sub>  |  |      | 23     | 45     |      |  |
| Rise Time  | t <sub>r</sub>      | $V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$  |      | 13     | 25     |      |  |
| Turn-Off Delay Time  | t <sub>d(off)</sub> | $\rm I_D \cong 10$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 $\Omega$                  |      | 29     | 55     |      |  |
| Fall Time  | t <sub>f</sub>      |  |      | 12     | 24     | no   |  |
| Turn-On Delay Time   | t <sub>d(on)</sub>  |  |      | 11     | 22     | ns   |  |
| Rise Time  | t <sub>r</sub>      | $V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$  |      | 10     | 20     | -    |  |
| Turn-Off Delay Time  | t <sub>d(off)</sub> | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$             |      | 22     | 45     |      |  |
| Fall Time  | t <sub>f</sub>      |  |      | 8      | 16     |      |  |
| Drain-Source Body Diode and Schottky                                 | Characteris         | tics   |      |        |        |      |  |
| Continuous Source-Drain Diode Current                                | ا <sub>S</sub>      | T <sub>C</sub> = 25 °C   |      |        | 5.6    | ۸    |  |
| Pulse Diode Forward Current <sup>a</sup>                             | I <sub>SM</sub>     |  |      |        | 50     | A    |  |
| Body Diode Voltage   | V <sub>SD</sub>     | I <sub>S</sub> = 2 A   |      | 0.53   | 0.7    | V    |  |
| Body Diode Reverse Recovery Time                                     | t <sub>rr</sub>     |  |      | 17     | 30     | ns   |  |
| Body Diode Reverse Recovery Charge                                   | Q <sub>rr</sub>     |  |      | 5.5    | 10     | nC   |  |
| Reverse Recovery Fall Time   | t <sub>a</sub>      | I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C -                    |      | 8      |        |      |  |
| Reverse Recovery Rise Time   | t <sub>b</sub>      |  |      | 9      |        | ns   |  |

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

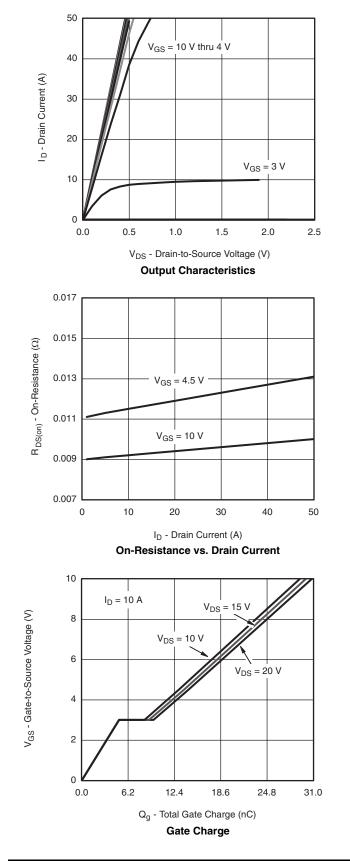
b. Guaranteed by design, not subject to production testing.

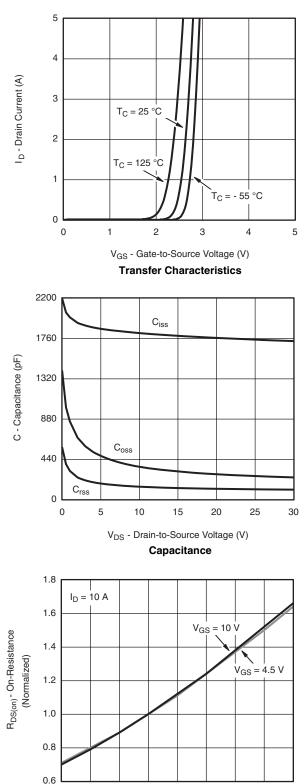
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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### **TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted





T<sub>J</sub> - Junction Temperature (°C) On-Resistance vs. Junction Temperature

50

75

100

- 50

- 25

0

25

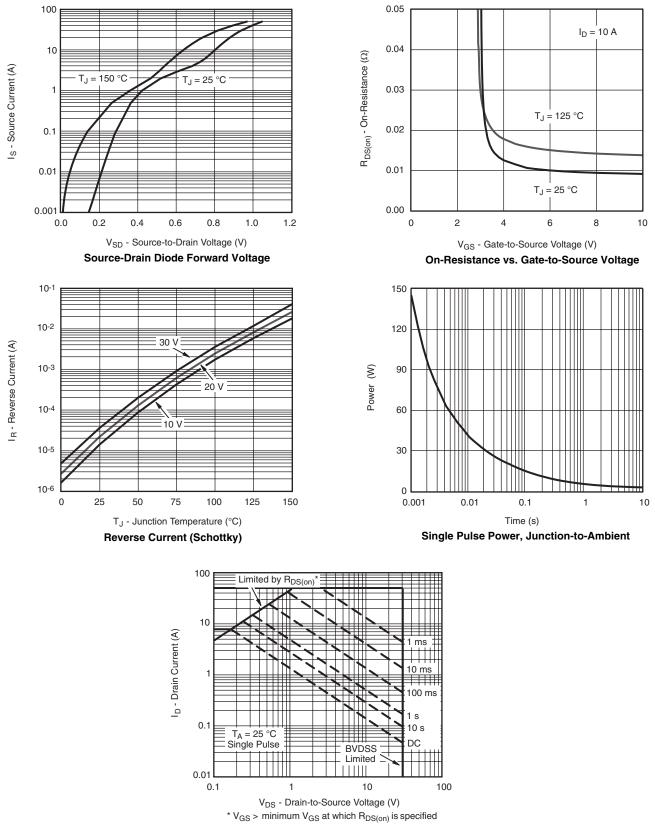
125

150

### **Vishay Siliconix**



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

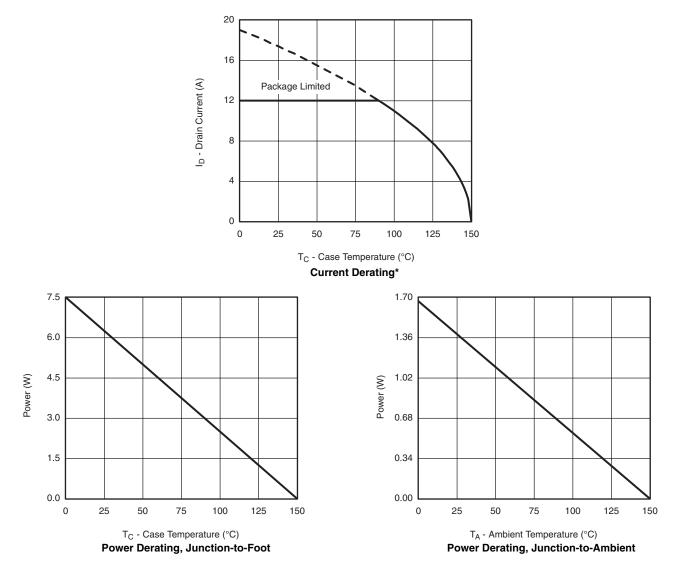


Safe Operating Area



### Si4646DY Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

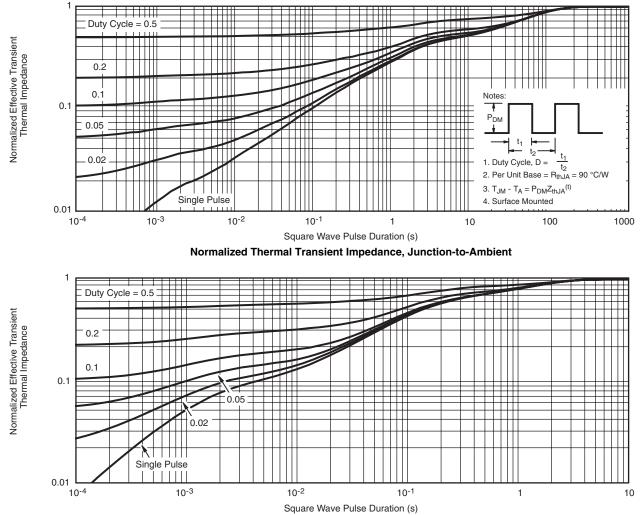


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

'Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg268762">www.vishay.com/ppg268762</a>.



# Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





|   | MILLIM   | IETERS | INCHES    |       |  |
|---|----------|--------|-----------|-------|--|
| DIM   | Min      | Мах    | Min       | Max   |  |
| A   | 1.35     | 1.75   | 0.053     | 0.069 |  |
| A <sub>1</sub>                              | 0.10     | 0.20   | 0.004     | 0.008 |  |
| В   | 0.35     | 0.51   | 0.014     | 0.020 |  |
| С   | 0.19     | 0.25   | 0.0075    | 0.010 |  |
| D   | 4.80     | 5.00   | 0.189     | 0.196 |  |
| E   | 3.80     | 4.00   | 0.150     | 0.157 |  |
| е   | 1.27 BSC |        | 0.050 BSC |       |  |
| н   | 5.80     | 6.20   | 0.228     | 0.244 |  |
| h   | 0.25     | 0.50   | 0.010     | 0.020 |  |
| L   | 0.50     | 0.93   | 0.020     | 0.037 |  |
| q   | 0°       | 8°     | 0°        | 8°    |  |
| S   | 0.44     | 0.64   | 0.018     | 0.026 |  |
| ECN: C-06527-Rev. I, 11-Sep-06<br>DWG: 5498 |          |        |           |       |  |

# **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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